

PRODUCT NUMBER
54775-XXX-XXLF

PLATING

1 = 0.76µm GOLD/GXT ON CONTACT AREAS

1.27µm NICKEL MIN

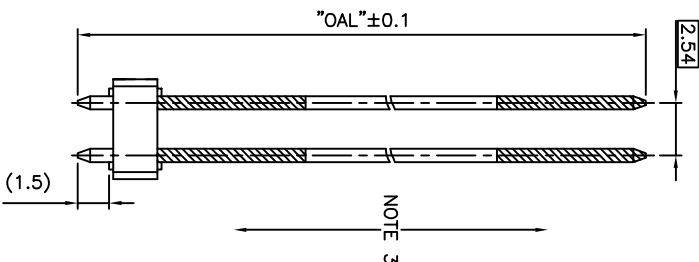
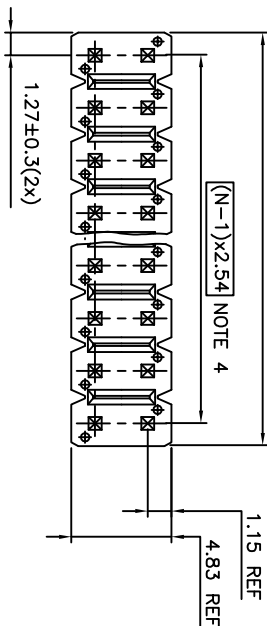
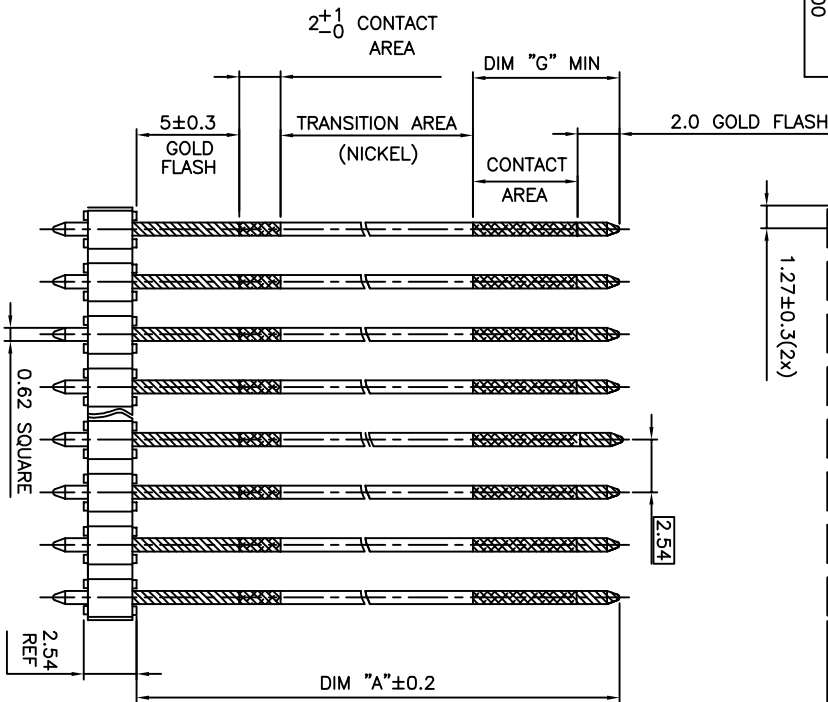
6 = 0.76µm GXT (PdNi WITH GOLD FLASH) ON CONTACT AREAS OVER 1.27µm NICKEL MIN (ALTERNATIVE 0.76µm GOLD/GXT ON CONTACT AREAS)

RoHS COMPATIBLE, SEE NOTE 5
TOTAL NB OF POSITIONS

PIN STYLE	DIM "A"	"OAL"	DIM "G" MIN
01	31.0	35.0	7.00
02	31.0	35.0	10.00

- NOTES:
- HOUSING MAT'L : HIGH TEMPERATURE THERMOPLASTIC. UL94V-0 COLOR: BLACK
 - PIN MATERIAL : PHOSPHOR BRONZE
 - 9N MIN RETENTION IN EITHER DIRECTION
 - TO DETERMINE DIMENSIONS :
N = NUMBER OF POSITIONS PER ROW
EXAMPLE : 8 POS PER ROW, N x 2.54 = 20.32mm
 - RoHS COMPATIBLE PRODUCT SPECIFICATIONS

- a - PLATING:
- "Lf" MEANS THE PRODUCT IS LEAD-FREE,
- b - MANUFACTURING PROCESS COMPATIBILITY
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
- c - LABELING:
- MEETS PACKAGING SPECS AS PER GS-14-920
- d - LEGAL STATEMENT: SEE GS-47-0004



mat'l. code				surface				tolerance				projection				product family			
ltr	ecm no	dr	date	ISO 1302	ISO 406	ISO 1101	tolerances unless otherwise specified	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm
H	F07-0207	LMU	07.06.06																
J	F08-0148	RTM	08.03.31																
K	B-19264	LMU	14.10.31																
E	F06-0196	LMU	06.06.13																
F	F06-0294	JCO	06.10.09																
G	F07-0136	JCO	07.02.19																
sheet	revision																		
index	sheet																		